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Dated: May 8, 2008

Signature: 

(Laura C. Brutman)

Docket No.: J0658.0006  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Jens Barrenscheen et al.

Application No.: 10/727,108

Confirmation No.: 4414

Filed: December 2, 2003

Art Unit: 2611

For: ARRANGEMENT COMPRISING A FIRST  
SEMICONDUCTOR CHIP AND A SECOND  
SEMICONDUCTOR CHIP CONNECTED  
THERETO

Examiner: J. F. A. Dsouza

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated April 7, 2008, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Amendments to the Drawings** begin on page 8 of this paper and include an attached replacement sheet.

**Remarks/Arguments** begin on page 9 of this paper.